



	LBA126L	Units
Blocking Voltage	250	V
Load Current	150	mA
Max R_{ON}	20	Ω

Features

- Small 8 Pin DIP Package
- Current Limit
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750V_{RMS} Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hookswitch
 - Dial Pulsing
 - Ground Start
 - Ringer Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

LBA126L is a Dual 1 Form-A solid state relay that has two independently controlled optically coupled MOSFETs with an additional current limiting circuit. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture to provide 3750 V_{RMS} of input to output isolation. The optically coupled inputs are controlled by highly efficient GaAIAs infrared LEDs. Dual pole OptoMOS relays provide a more compact design solution than discrete single pole relays in a variety of applications. The dual pole relays save board space by incorporating both relays in a single 8-pin package.

Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- Certified to:
 - EN 60950
 - EN 41003
 - IEC950
 - AS/NZS 3260

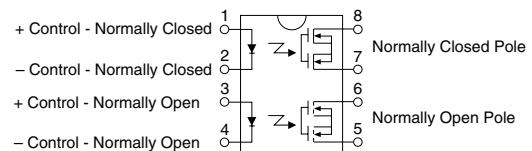
Ordering Information

Part #	Description
LBA126L	8 Pin DIP (50/Tube)
LBA126PL	8 Pin Flatpack (50/Tube)
LBA126PLTR	8 Pin Flatpack (1000/Reel)
LBA126LS	8 Pin Surface Mount (50/Tube)
LBA126LSTR	8 Pin Surface Mount (50/Reel)

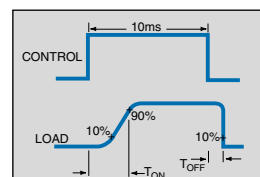
Pin Configuration

LBA126L Pinout

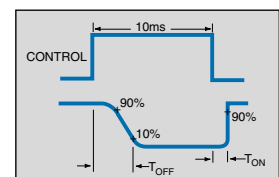
AC/DC Configuration



Switching Characteristics of Normally Open (Form A) Devices



Switching Characteristics of Normally Closed (Form B) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150 ¹	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Blocking Voltage DC or AC peak	-	-	250	V
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	800 ²	mW
Isolation Voltage Input to Output	3750	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature DIP Package	-	-	+260	°C
Flatpack/Surface Mount Package (10 Seconds Max.)	-	-	+220	°C

¹ Derate Linearly 1.33 mW/°C

² Derate Linearly 6.67 mW/°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this data sheet is not implied. Exposure of the device to the absolute maximum ratings for an extended period may degrade the device and effect its reliability.

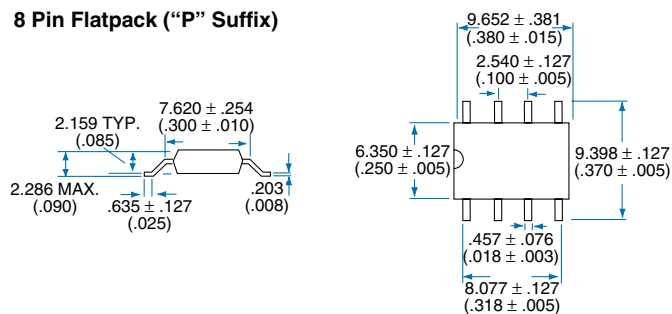
Electrical Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Current *(Continuous) AC/DC Configuration	-	I _{ON}			150	mA
Peak Load Current	10ms	I _{LPK}	-	-	400	mA
On-Resistance AC/DC Configuration	I _L =150mA	R _{ON}	-	-	20	Ω
Off-State Leakage Current	V _L =250V	I _{LEAK}	-	-	1	μA
Switching Speeds Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	5	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	50	-	pF
Load Current Limiting		I _{CL}	170	235	280	mA
Input Characteristics @ 25°C						
Input Control Current	I _L =150mA	I _F	5	-	50	mA
Input Dropout Current	-	-	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

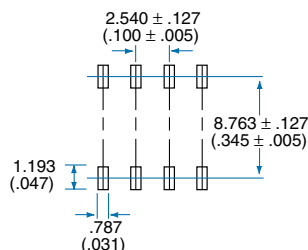
*NOTE: If both poles operate simultaneously load current must be derated so as not to exceed the package power dissipation value.

MECHANICAL DIMENSIONS

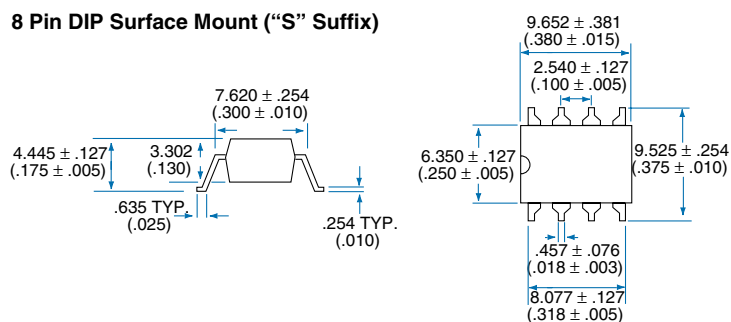
8 Pin Flatpack ("P" Suffix)



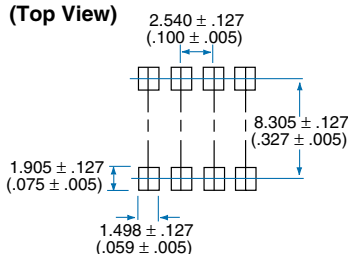
PC Board Pattern (Top View)



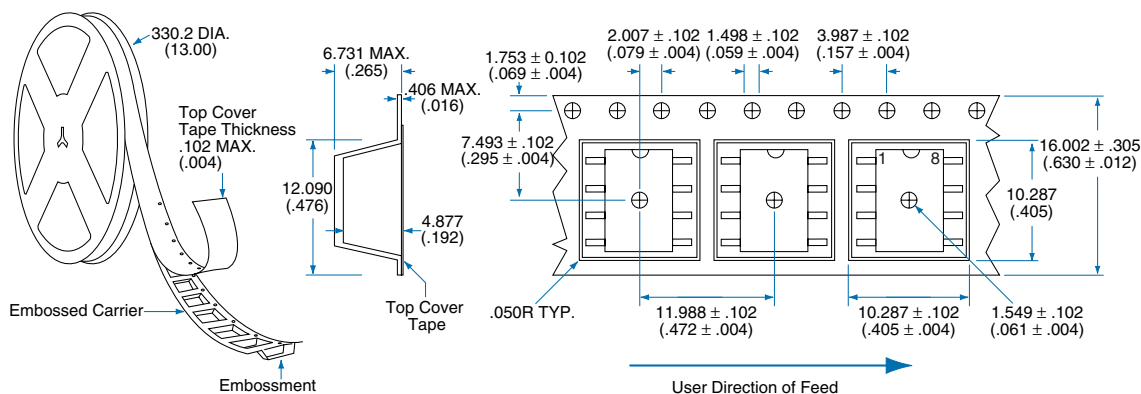
8 Pin DIP Surface Mount ("S" Suffix)



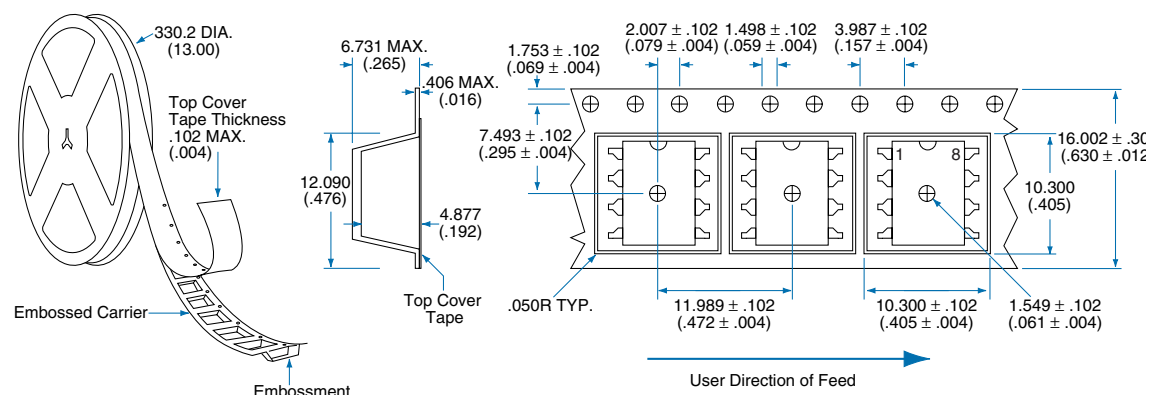
PC Board Pattern (Top View)



Tape and Reel Packaging for 8 Pin Flatpack Package



Tape and Reel Packaging for 8 Pin Surface Mount Package



Dimensions
mm
(inches)



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